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Vishay Siliconix

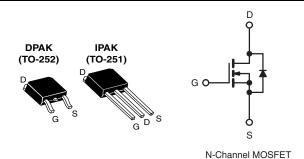
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	60	60				
R _{DS(on)} (Ω)	V _{GS} = 5.0 V	V _{GS} = 5.0 V 0.10				
Q _g (Max.) (nC)	18	18				
Q _{gs} (nC)	4.5	4.5				
Q _{gd} (nC)	12	12				
Configuration	Sing	Single				



FEATURES

- Dynamic dV/dt rating
- Surface mount (IRLR024, SiHLR024)
- Straight lead (IRLU024, SiHLU024)
- Available in tape and reel
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRLU, SiHLU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lead (Pb)-free and Halogen-free	-	SiHLR024TRL-GE3	SiHLR024TR-GE3	SiHLU024-GE3		
Load (Dh) fron	IRLR024PbF	-	IRLR024TRPbF ^a	IRLU024PbF		
Lead (Pb)-free	SiHLR024-E3	-	SiHLR024T-E3 a	SiHLU024-E3		

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	60	V	
Gate-Source Voltage			V_{GS}	± 10	7 °	
Continuous Drain Current	V _{GS} at 5.0 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I-	14		
Continuous Drain Current V_{GS} at 5.0 V $T_{C} = 100$		T _C = 100 °C	I _D	9.2	Α	
Pulsed Drain Current ^a			I _{DM}	56		
Linear Derating Factor				0.33	W/°C	
Linear Derating Factor (PCB Mount) e				0.020	VV/ C	
Single Pulse Avalanche Energy ^b			E _{AS}	53	mJ	
Maximum Power Dissipation	T _C =	25 °C	В	42	w	
Maximum Power Dissipation (PCB Mount) e T _A = 25 °C			P_D	2.5] vv	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak Temperature)	d for	10 s		260]	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 541 μ H, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12).
- c. $I_{SD} \le 17$ A, $dI/dt \le 140$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

IRLR024, IRLU024, SiHLR024, SiHLU024

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	-	110	
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				,	ı	ı	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.068	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 V	-	-	± 100	nA
Zana Oata Waltana Duain Ourmant		V _{DS} :	= 60 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Durin On the On Olete Business	5	$V_{GS} = 5.0 \text{ V}$	I _D = 8.4 A ^b	-	-	0.10	
Drain-Source On-State Resistance	$R_{DS(on)}$	V _{GS} = 4.0 V	I _D = 7.0 A ^b	-	-	0.14	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	25 V, I _D = 8.4 A ^b	7.3	-	-	S
Dynamic		•			I.	I.	
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,		870	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	360	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	53	-	
Total Gate Charge	Qg			-	-	18	
Gate-Source Charge	Q _{gs}	$V_{GS} = 5.0 \text{ V}$	$I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b	-	-	4.5	nC
Gate-Drain Charge	Q _{gd}	1	see fig. 6 and 13 °		-	12	1
Turn-On Delay Time	t _{d(on)}			-	11	-	
Rise Time	t _r	V _{DD} :	= 30 V, I _D = 17 A,	-	110	-]
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.0 \Omega, R_D = 1.7 \Omega, \text{see fig. 10}^{ \text{b}}$		-	23	-	ns
Fall Time	t _f			-	41	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") 1	'	-	4.5	-	-11
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	14	- A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	56	A
Body Diode Voltage	V_{SD}	T _J = 25 °C	, I _S = 14 A, V _{GS} = 0 V ^b	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C 1	17 A all/alt 100 A / h	-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 17 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^{\text{b}}$		-	0.75	1.5	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

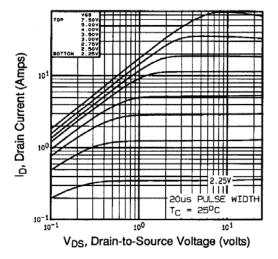


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

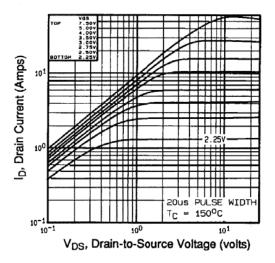


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

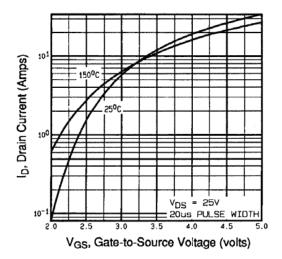


Fig. 3 - Typical Transfer Characteristics

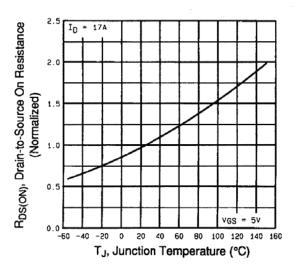


Fig. 4 - Normalized On-Resistance vs. Temperature



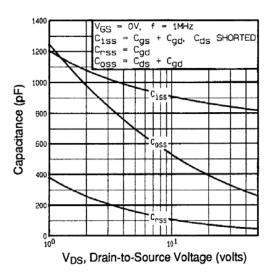


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

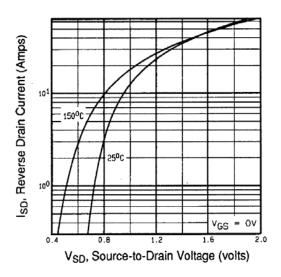


Fig. 7 - Typical Source-Drain Diode Forward Voltage

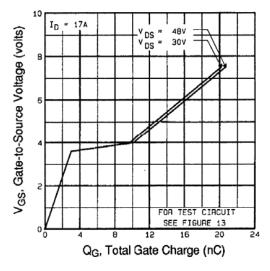


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

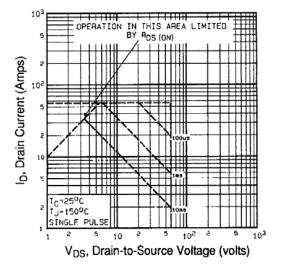


Fig. 8 - Maximum Safe Operating Area

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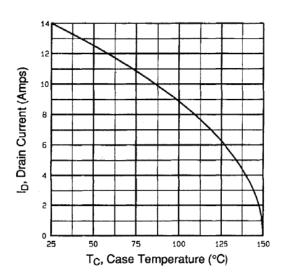


Fig. 9 - Maximum Drain Current vs. Case Temperature

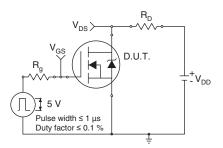


Fig. 10a - Switching Time Test Circuit

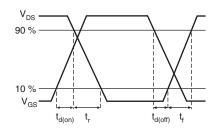


Fig. 10b - Switching Time Waveforms

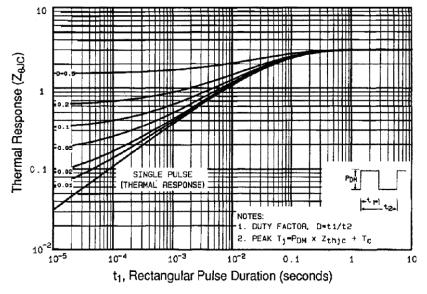


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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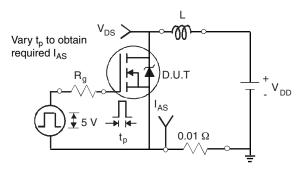


Fig. 12a - Unclamped Inductive Test Circuit

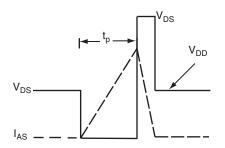


Fig. 12b - Unclamped Inductive Waveforms

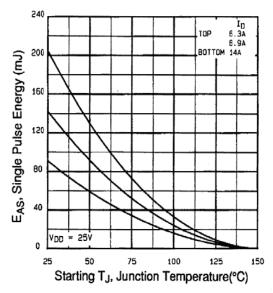


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

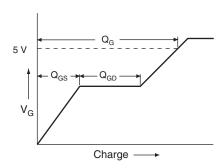


Fig. 13a - Basic Gate Charge Waveform

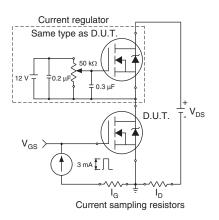
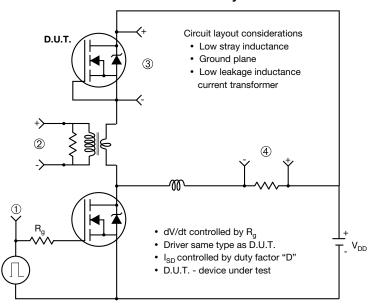


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



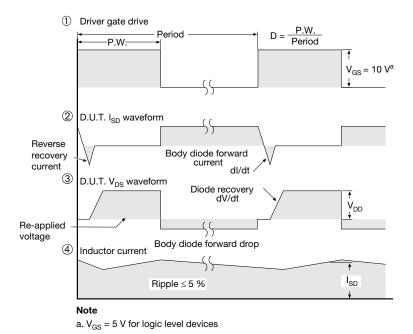


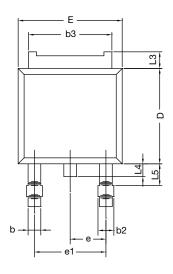
Fig. 14 - For N-Channel

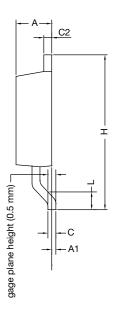
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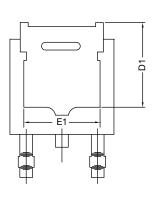


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







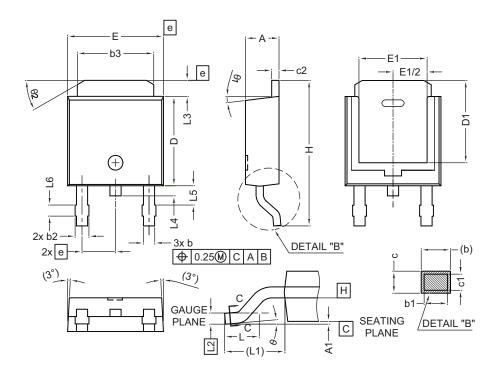
	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS			
DIM.	MIN.	MAX.		
Α	2.18	2.39		
A1	-	0.13		
b	0.65	0.89		
b1	0.64	0.79		
b2	0.76	1.13		
b3	4.95	5.46		
С	0.46	0.61		
c1	0.41	0.56		
c2	0.46	0.60		
D	5.97	6.22		
D1	5.21	=		
E	6.35	6.73		
E1	4.32	-		
е	2.29 BSC			
Н	9.94	10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ł ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

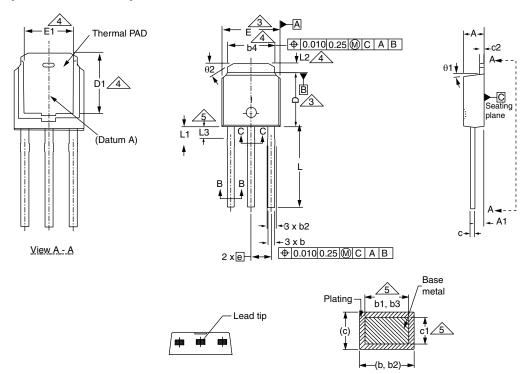
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29	BSC	2.29	BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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